

# AN14238

## Get started with EdgeLock A30 secure authenticator support package

Rev. 1.0 — 15 January 2025

Application note

### Document information

Information	Content
Keywords	EdgeLock A30 secure authenticator, NX Middleware
Abstract	This document is the entry point for getting familiar with EdgeLock A30 support package contents and how to get started with them.



# 1 About EdgeLock A30 secure authenticator

EdgeLock A30 is a secure authentication IC for IoT platforms, electronic accessories and consumable devices such as home electronic devices, mobile accessories and medical supplies.

EdgeLock A30 supports on-chip ECC key generation to make sure that private keys are never exposed outside the IC. It performs cryptographic operations for security critical communication and control functions. EdgeLock A30 is Common Criteria EAL 6+ security certified with AVA\_VAN.5 on product level and supports a generic Crypto API providing AES, ECDSA, ECDH, SHA, HMAC and HKDF cryptographic functionality.

- Asymmetric cryptography features support 256-bit ECC over the NIST P-256 and brainpool P256r1 curves.
- Symmetric cryptography features support both AES-128 and AES-256.
- PKI-based mutual authentication based on the Sigma-I protocol.
- Symmetric three pass Mutual Authentication protocol compatible with NTAG42x and MIFARE DesFire EV2, DesFire EV3 and DesFire Light.
- Secure messaging channel using either AES-128 or AES-256 session encryption/decryption and MAC.

The Common Criteria security certification ensures that the IC security measures and protection mechanisms have been evaluated against sophisticated noninvasive and invasive attack scenarios.

- A30 supports an I<sup>2</sup>C contact interface and has two additional GPIOs.
- A30 supports a low-power design, and consumes only 5 µA at Deep-Power-Down mode when an external VDD is supplied.

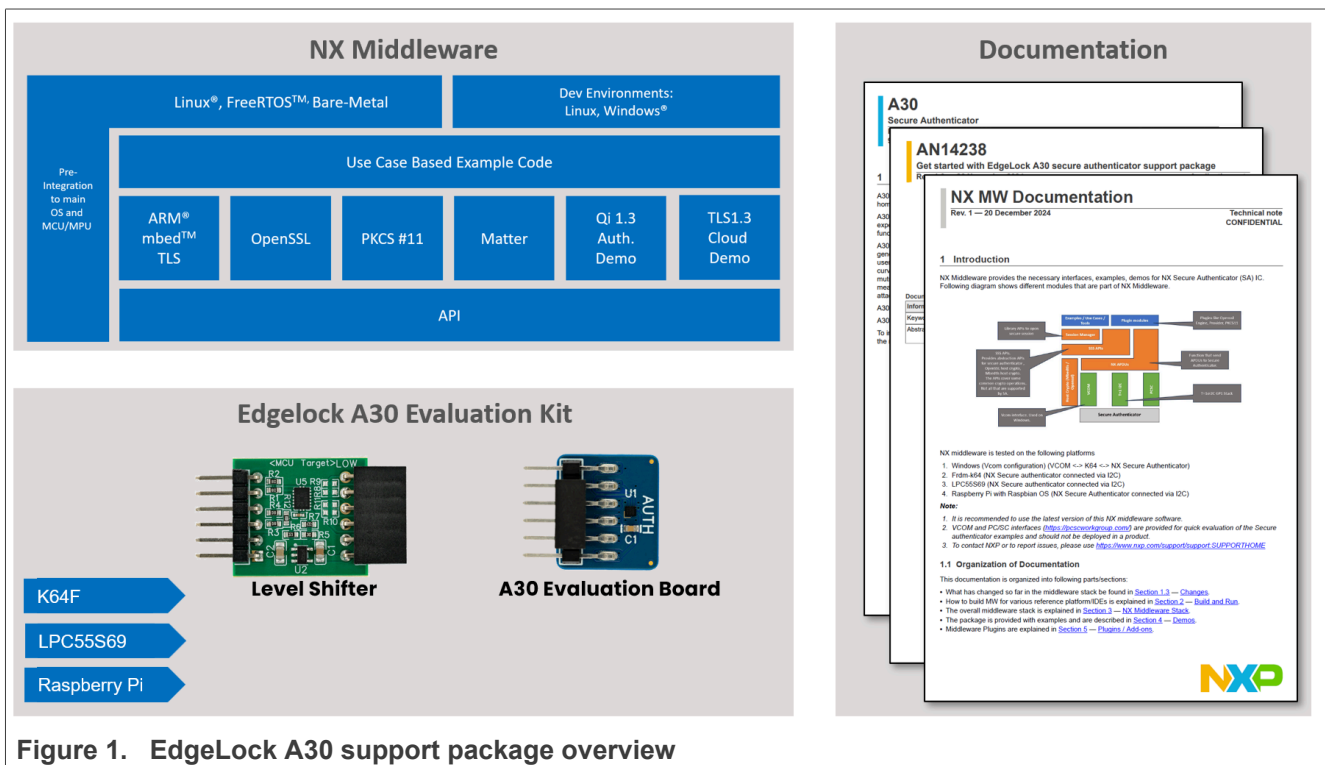


Figure 1. EdgeLock A30 support package overview

Delivered as a ready-to-use solution, the EdgeLock A30 includes a complete product support package that simplifies design-in and reduces time to market. The EdgeLock A30 support package offers:

- EdgeLock A30 evaluation kit
- NX Middleware
  - Software enablement for MCUs and MPUs.
  - Integration with the most common cryptographic libraries like OpenSSL, Mbed TLS and PKCS #11.
  - Multi-platform software enablement targeting freeRTOS and Linux as well as Windows as evaluation platform.
  - Sample code for major IoT and secure authentication use cases.
- Documentation

This document lists the existing material within EdgeLock A30 support package, organized in the following sections:

- [Section 2](#) EdgeLock A30 evaluation kit
- [Section 3](#) Supported MCU/MPU boards
- [Section 4](#) NX Middleware
- [Section 6](#) Supported EdgeLock A30 documentation

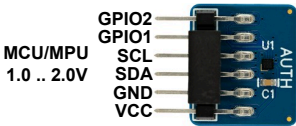

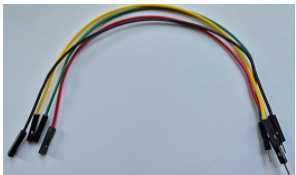
## 2 EdgeLock A30 evaluation kit

The EdgeLock A30 secure authenticator is supported by an A30 evaluation kit including:

- EdgeLock A30 evaluation boards
- Level shifter board
- Jumper wires

[Table 1](#) summarizes the contents of the evaluation kit.

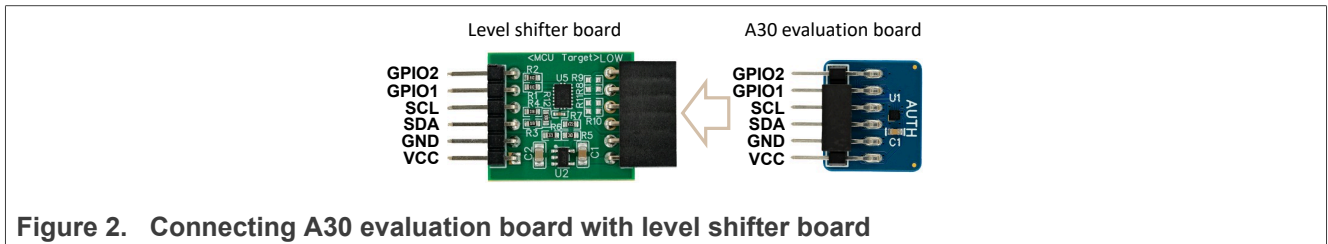
**Table 1. EdgeLock A30 evaluation kit A30-EVAL**

Part number	12NC	Number of pieces	Content	Picture
A30-EVAL	9355050 94598	3	A30 evaluation board	
		1	Level shifter board	
		6	Jumper wires	

EdgeLock A30 is designed for battery-operated applications and for MCU/MPUs with a supply voltage of 1.8 V. Therefore, the operating supply voltage range of EdgeLock A30 is specified from 1.0 V to 2.0 V.

Although current MCU families typically support 1.8 V operation voltage, many MCU evaluation kits still operate with 3.3V or even 5V. To support rapid prototyping, the EdgeLock A30 evaluation kit includes a level shifter which translates the voltage level accordingly if needed.

[Figure 2](#) shows how to connect the Level Shifter and A30 board.

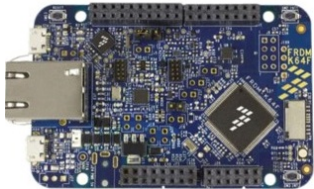
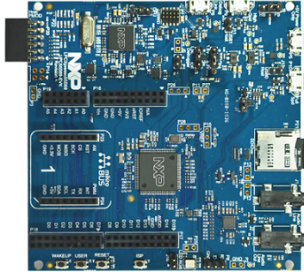


### 3 Supported MCU/MPU boards

The EdgeLock A30 secure authenticator IC is designed to be used as a part of an IoT system. It works as an auxiliary security authenticator device attached to a host controller (MCU or MPU board). The host controller communicates with EdgeLock A30 through an I<sup>2</sup>C interface with the host controller being the controller and the EdgeLock A30 being the target.

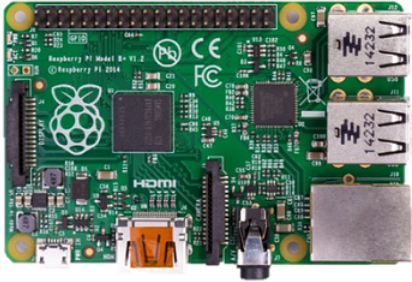
The EdgeLock A30 can be connected to any MCU/MPU on the market supporting the I<sup>2</sup>C interface. To enable easy evaluation of the EdgeLock A30, the NX Middleware supports the NXP FRDM-K64F and the LPCXpresso 55S69 demo board as an MCU reference platform.

Table 2. FRDM-K64F details

Part number	12NC	Content	Picture
<a href="#">FRDM-K64F</a>	935326293598	Freedom development platform for Kinetis K64, K63 and K24 MCUs	
<a href="#">LPC55S69-EVK</a>	935377412598	LPCXpresso55S69 development board	

The Raspberry Pi is used to demonstrate the embedded Linux enablement of A30. The middleware supports all different Raspberry Pi board versions and was tested on Raspberry Pi 4 Model B.

Table 3. Raspberry Pi

Part number	Content	Picture
<a href="#">Raspberry Pi</a>	Raspberry Pi model	

## 4 NX Middleware

### 4.1 Overview

The NX Middleware is a single software stack designed to facilitate the integration of EdgeLock A30 secure authenticator IC into your MCU or MPU software. The NX Middleware abstracts the commands and communication interface exposed by EdgeLock A30. It is directly accessible from stacks like mbedTLS, OpenSSL and PKCS #11. In addition, it includes code examples for quick integration of features and use cases such as TLS and AWS cloud service onboarding. It also comes with support for reference MCU/MPU platforms and can be ported to multiple host platforms and host operating systems.

Figure 3 is a simplified representation of the layers and components of NX Middleware:

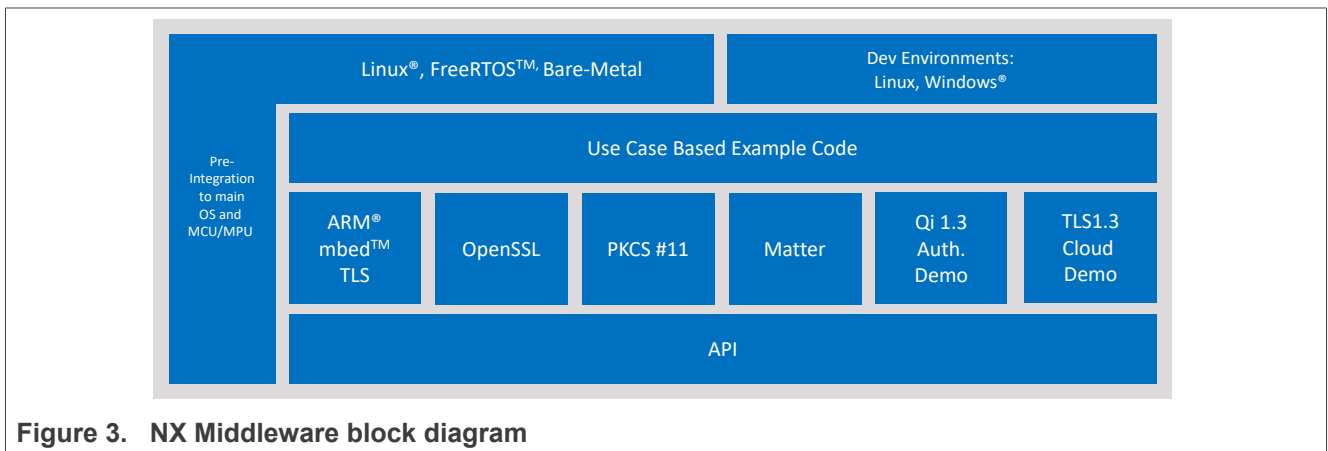


Figure 3. NX Middleware block diagram

The NX Middleware is delivered with CMake files that include the set of directives and instructions describing the project's source files and targets. The CMake files allow developers to build NX Middleware in their target platform, enable or disable features or change setting flags, among others.

The CMake based compilation option is provided as a convenient way for developers to run a project example on different target platforms:

- Windows/Linux PC for evaluation purpose
- MCU boards
- MPU boards

The NX Middleware has built-in cryptographic and abstracts the commands as well the communication interface exposed by NXP EdgeLock A30 secure authenticator IC. The NX Middleware is directly accessible form the following crypto software stacks:

- ARM mbedTLS
- OpenSSL
- PKCS #11

The NX Middleware can be downloaded via GitHub <https://github.com/NXP/nxmw>.

**Note:** Currently only the Linux platform can be downloaded from GitHub. The Windows, the [FRDM-K64F](#) and [LPC55S69-EVK](#) MCU platform releases are currently provided as a .zip package and can be downloaded from [www.nxp.com/A30](http://www.nxp.com/A30). These platforms will be added to GitHub in subsequent releases and will replace the zip package thereafter.

4.2 Architecture overview

Figure 4 gives a brief overview of the NX Middleware.

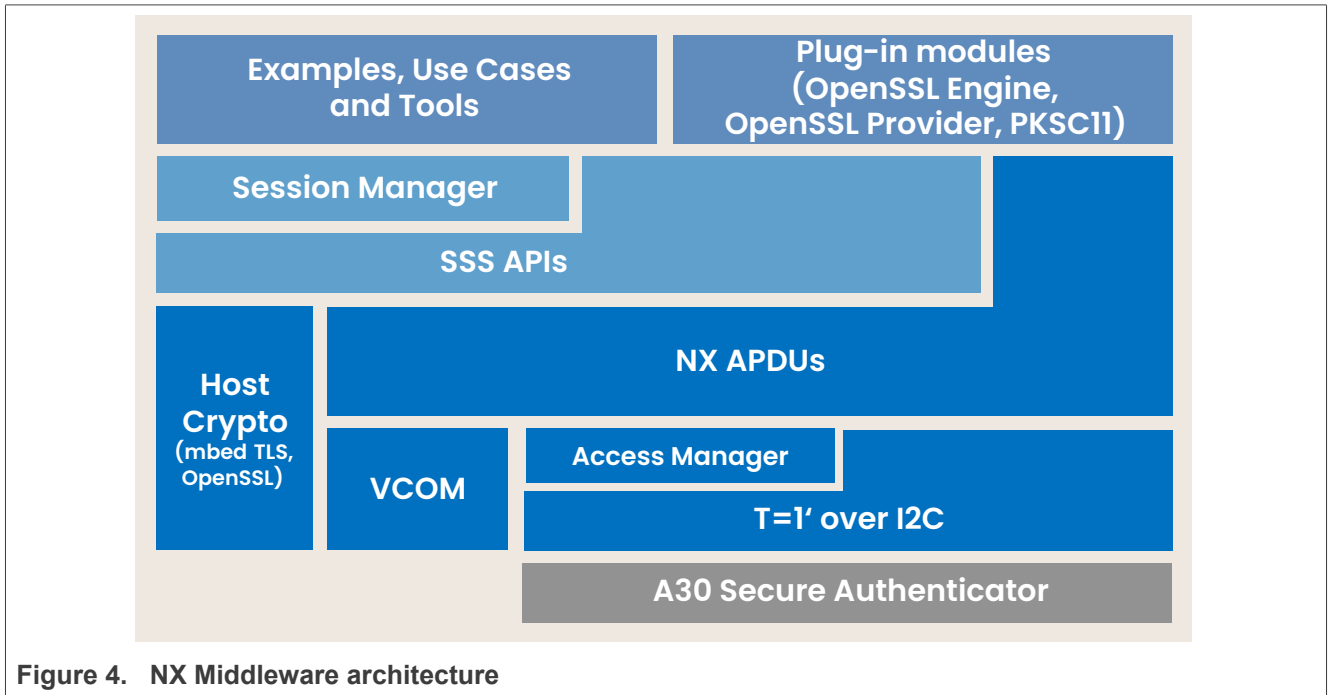


Figure 4. NX Middleware architecture

- Session Manager
  - APIs to open a session. The following sessions are supported:
    - Plain session
    - PKI based asymmetric Mutual Authentication (Sigma-I-Verifier or Sigma-I-Prover)
    - AES-based Symmetric Mutual Authentication
  - Note: Both mutual authentication methods initiate a MIFARE DESFire compatible EV2 secure messaging channel (authenticated session).
- SSS APIs
  - Provides abstraction APIs for EdgeLock A30, OpenSSL and mbedTLS host crypto.
  - SSS APIs are supporting common crypto operations.
- NX APDUs
  - Implements the EdgeLock A30 authenticator commands (APDUs)
- Access Manager
  - Manage access from multiple Linux processes to EdgeLock A30. Client processes connect over the JRCPv1 protocol to the Access Manager.

T=1' over I<sup>2</sup>C communication protocol according to Global Platform.

### 4.3 Code documentation

The code documentation provided as part of NX Middleware package in PDF format and as a part of the GitHub release. The primary audience are programmers, developers, system architects and system designers. [Figure 5](#) gives an overview of the PDF document contents.

<b>1. Introduction</b>	<b>5. Plugins / Add-ons</b>
1.1 Organization of Documentation	5.1 Introduction on OpenSSL engine
1.2 Folder Structure	5.2 Introduction on OpenSSL provider
1.3 Changes	5.3 PKCS#11 Plugin
<b>2. Build and Run</b>	5.4 PSA (Platform Security Architecture)
2.1 Setup A30/NTAG X DNA Sample	<b>6. MCUXpresso Projects</b>
2.2 CMake	6.1 FRDM-K64F
2.3 Windows	6.2 LPC55S69
2.4 FRDM-K64F	<b>7. Porting Guide</b>
2.5 Raspberry Pi Build	7.1 New Platform Support Using CMake Build
2.6 CMake Options	7.2 MCUXpresso Project for new platform
<b>3. NX Middleware Stack</b>	7.3 Porting to new Host Crypto
3.1 NX Secure Authenticator session	<b>8. Appendix</b>
3.2 NX Middleware APIs	8.1. Setting up MCUXpresso IDE
3.3 Write your application	8.2. Development Platforms
<b>4. Demos</b>	8.3. VCOM
4.1 Utilities	8.4. Feature File - fsl_sss_ftr.h
4.2 Crypto Examples	8.5. NX MW APIs
4.3 Management and Configuration Examples	
4.4 TLS Examples	
4.5 Cloud Examples	
4.6 Access Manager	
4.7 Other Examples	

Figure 5. NX Middleware contents

The PDF version of the NX Middleware documentation (NXMW.pdf) is located in the `simw-top\` folder as shown in [Figure 6](#):



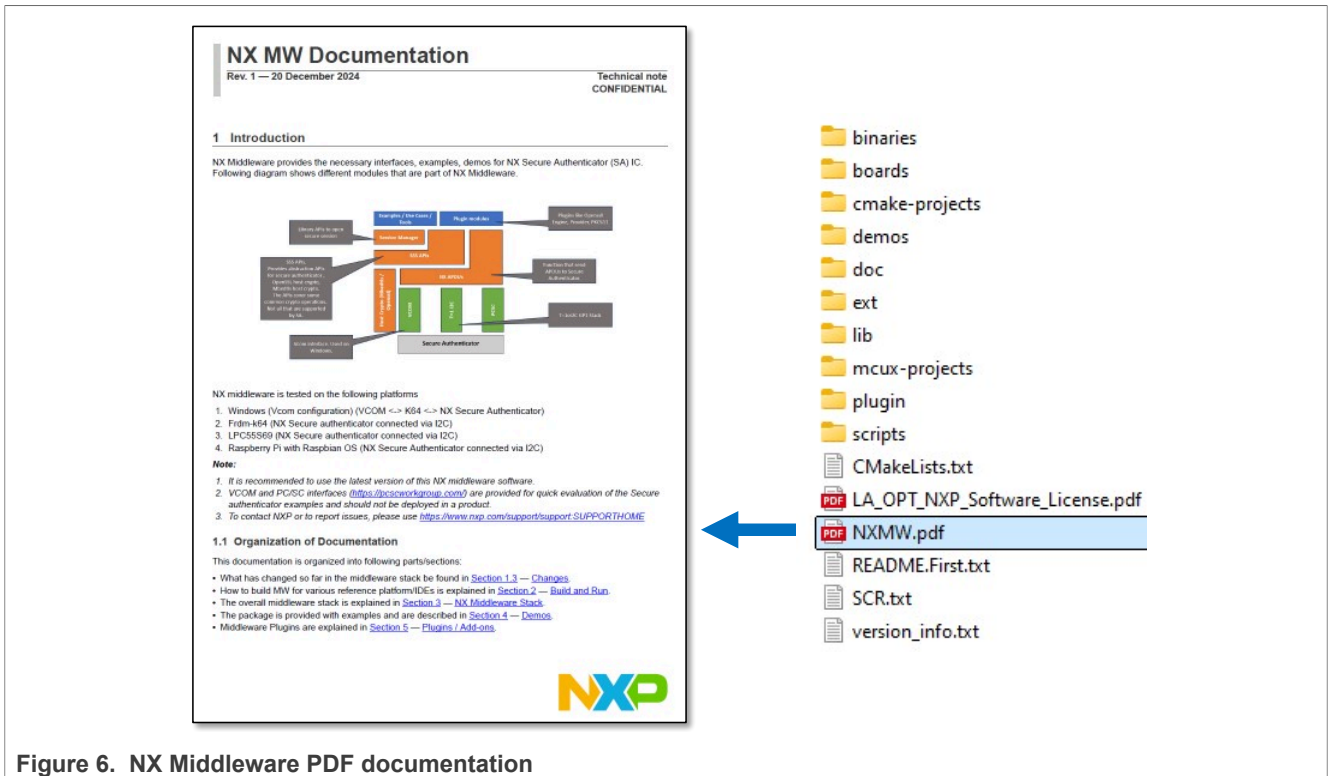


Figure 6. NX Middleware PDF documentation

### 4.4 Evaluation using a Windows PC

For rapid evaluation and prototyping, the NX Middleware supports building and running the stack on a Windows PC without the need to port to the final target MCU/MPU platform. To connect the EdgeLock A30 evaluation board to a Windows PC, an NXP FRDM-K64 board with the pre-compiled firmware `nx_vcom-T1oI2C_GP1_0-frdmk64f.bin` is required. The FRDM-K64 board must be connected to a Windows PC via USB (K64 USB port - see [Figure 8](#)). The EdgeLock A30 and the level shifter board must be connected as shown in [Figure 8](#).

When the NX Middleware is compiled for the Windows platform, all low-level EdgeLock A30 APDU commands and responses are transmitted over a VCOM interface instead of the T=1 over I<sup>2</sup>C protocol. The `nx_vcom-T1oI2C_GP1_0-frdmk64f.bin` firmware acts as a bridge between the PC VCOM interface and the EdgeLock A30 secure authenticator I<sup>2</sup>C interface. The `nx_vcom-T1oI2C_GP1_0-frdmk64f.bin` firmware performs the complete T=1 communication over I<sup>2</sup>C.

To avoid the need of installing MCUXpresso development tools, NX Middleware provides the FRDM-K64 `nx_vcom-T1oI2C_GP1_0-frdmk64f.bin` firmware as a pre-compiled binary. The FRDM-K64 CPU supports flashing the firmware via a USB mass storage device (see [Figure 7](#)). Therefore, flashing a firmware binary to the FRDM-K64 MCU can be easily done by drag and drop the firmware binary into the FRDM-K64 USB mass storage folder.

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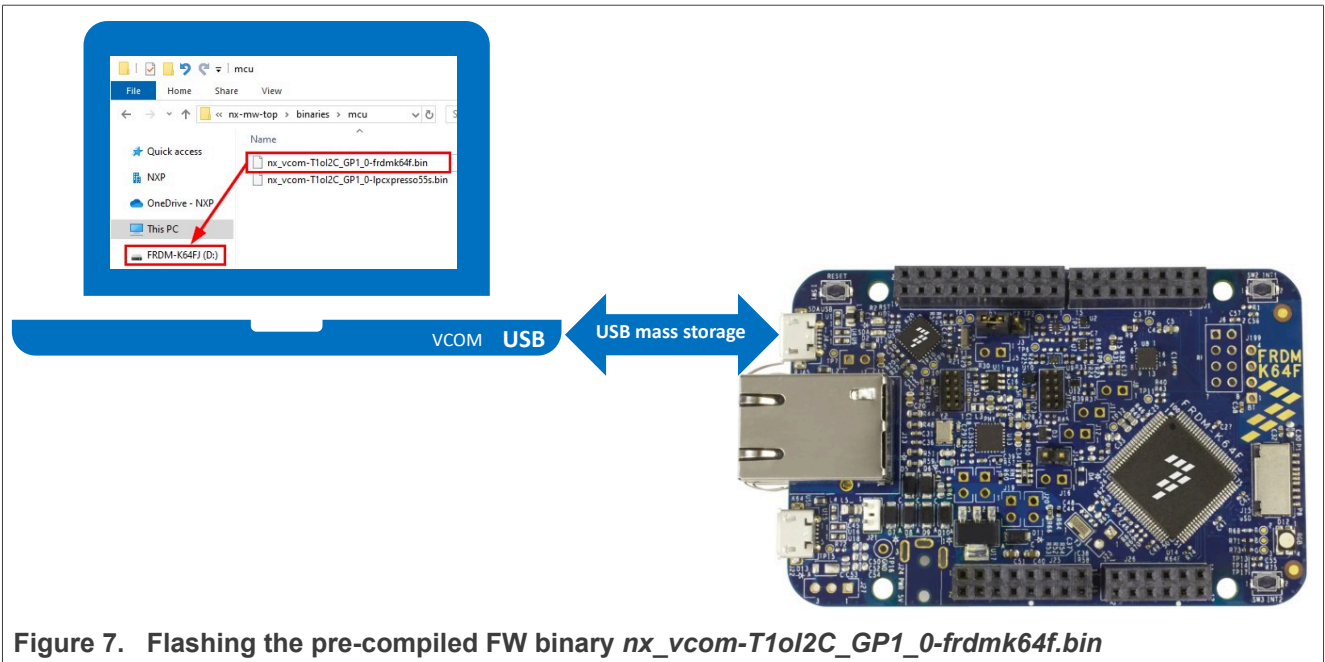


Figure 7. Flashing the pre-compiled FW binary `nx_vcom-T1oI2C_GP1_0-frdmk64f.bin`

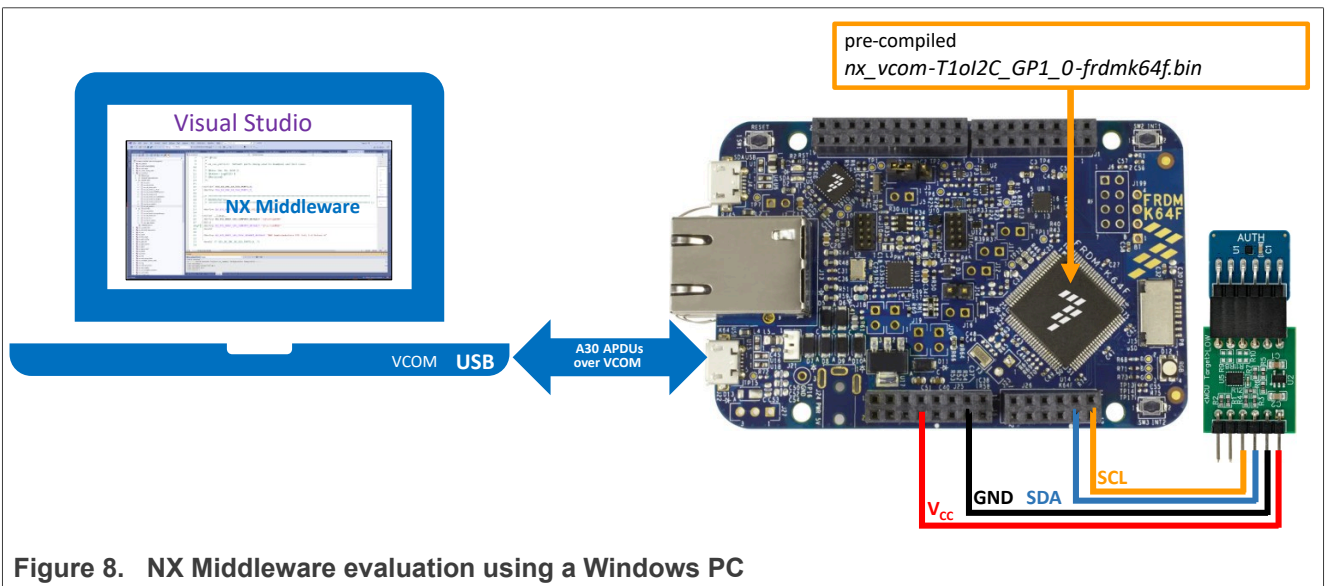


Figure 8. NX Middleware evaluation using a Windows PC

For further details please refer to NX Middleware documentation chapter 2.2 Build and Run Windows.

The NX Middleware also provides a pre-compiled binary for the LPC55S69-EVK. The `nx_vcom-T1oI2C_GP1_0-lpcxpresso55s.bin` file can be loaded, for example using the GUI Flash Tool integrated in MCUXpresso IDE. For further details please refer to MCUXpresso IDE User Guide chapter 17.1.3 Advanced GUI Flash Tool programming an arbitrary binary.

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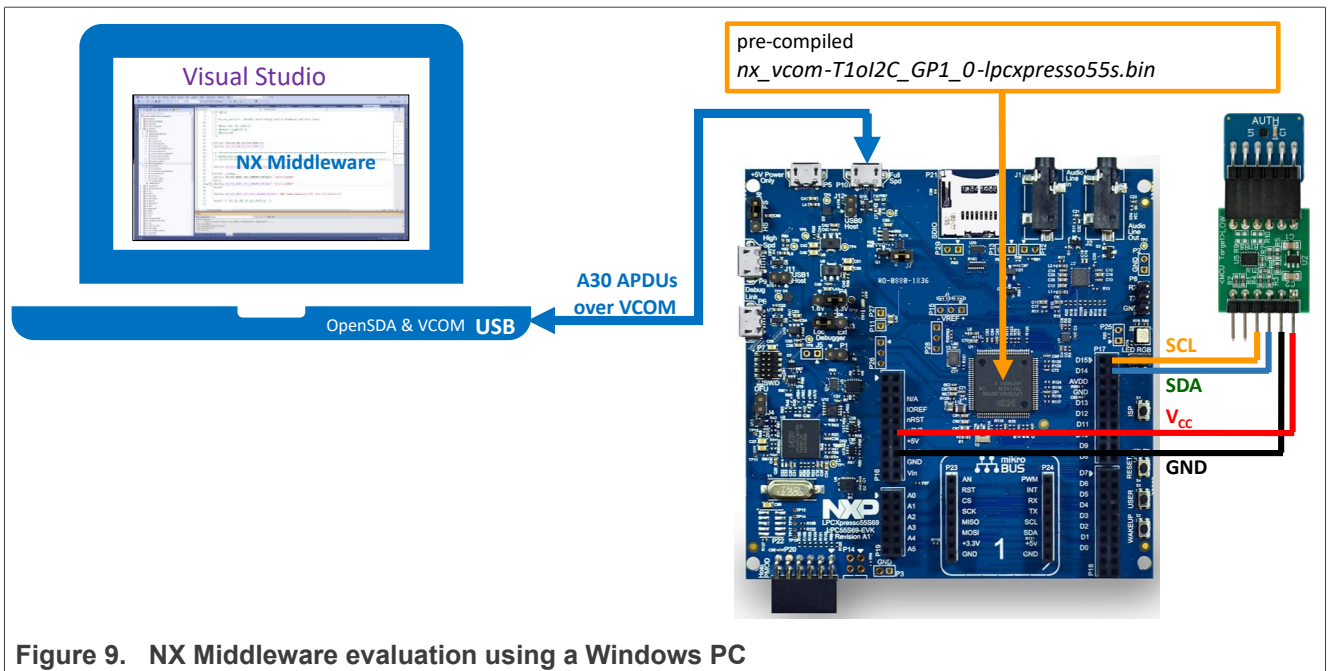


Figure 9. NX Middleware evaluation using a Windows PC

### 4.5 Evaluation using a MCU board

The NX Middleware includes a set of MCU examples that demonstrate the use of A30 in the latest authenticator security use cases. The [FRDM-K64F](#) and [LPC55S69-EVK](#) boards are used as a reference MCU platform and MCUXpresso as a reference development IDE. The MW stack was designed to allow easy porting to other MCU/MPU platforms. For further details please refer to the MW documentation chapter 7. Porting Guide.

FRDM-K64/LPC55S69 project examples can be either imported into MCUXpresso as:

- A standalone MCUXpresso projects (see MW document chapter 6 MCUXpresso Projects)
- A CMake project (see MW document chapter 2.4. FRDM-K64F and chapter 8.2.1. Freedom K64F with MCUXpresso IDE)

These project examples offer a quick way to evaluate EdgeLock A30 features, and its source code can be re-used for customer specific implementations. To execute the code, the FRDM-K64F board must be connected to a Windows PC via USB (Open SDA USB port - see [Figure 10](#)). The EdgeLock A30 and the level shifter board must be connected as shown in [Figure 10](#).

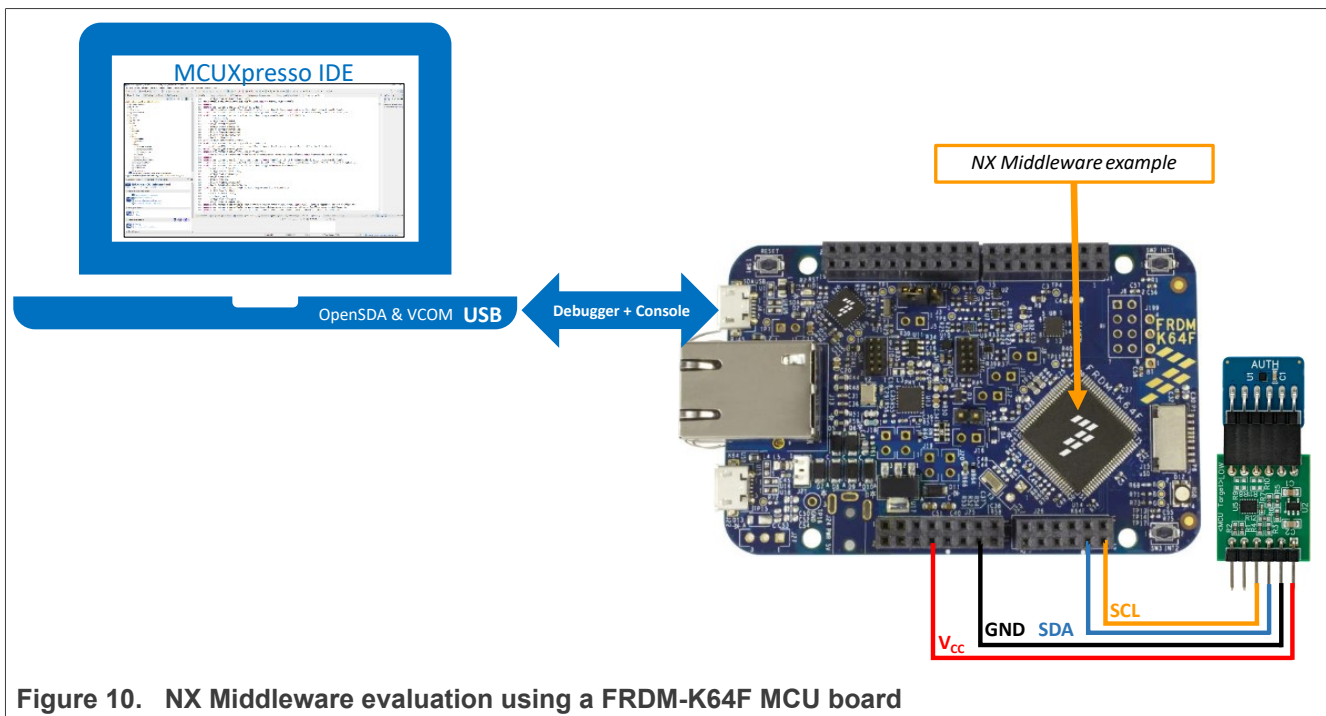


Figure 10. NX Middleware evaluation using a FRDM-K64F MCU board

[Figure 11](#) shows the setup using a LPC55S69-EVK.

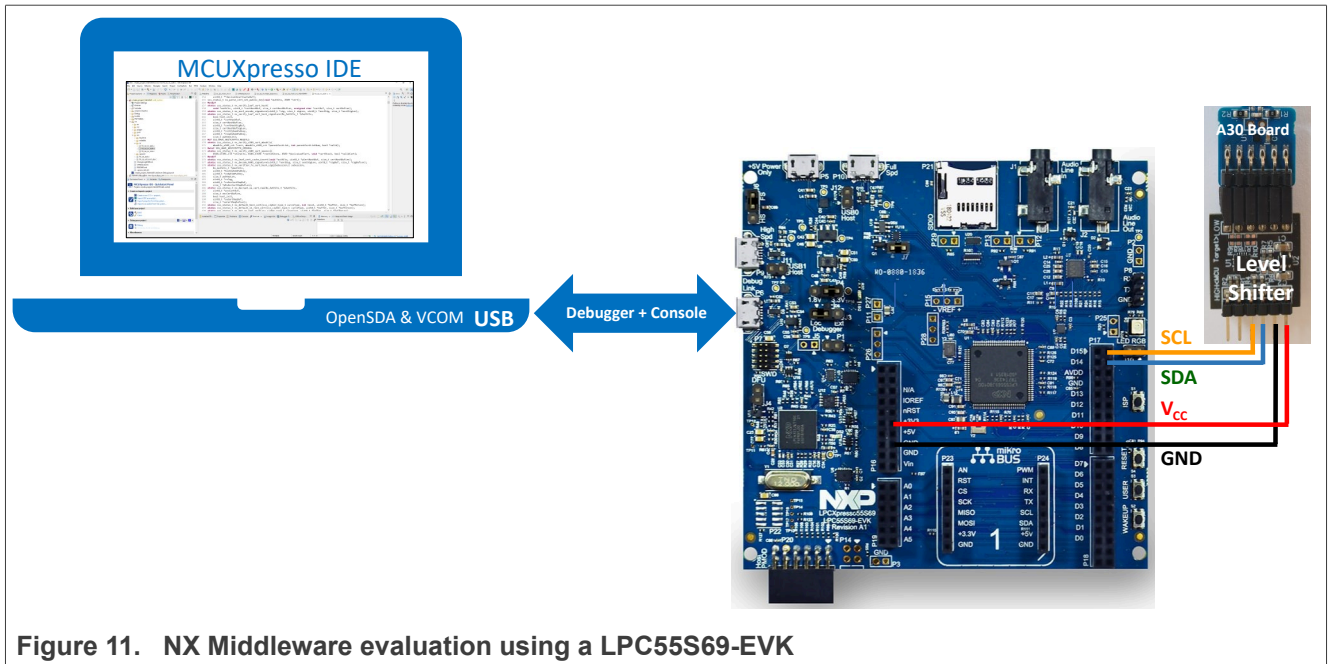


Figure 11. NX Middleware evaluation using a LPC55S69-EVK

#### 4.6 Evaluation using Raspberry Pi

The NX Middleware offers several components and example code to implement and verify EdgeLock A30 on devices running an embedded Linux distribution:

- OpenSSL engine compatible with OpenSSL versions 1.1.1
- OpenSSL provider compatible with OpenSSL versions 3.0
- PKCS#11 Plugin
- SSS API

The Raspberry Pi was selected as a reference MPU platform running embedded Linux. For further details refer to the following chapters in the MW documentation:

- 2.4. Raspberry Pi Build
- 4.4.1. OpenSSL Engine: TLS Client example
- 4.5.2. AWS Demo for Raspberry Pi
- 4.6 Access Manager
- 5.1. Introduction on OpenSSL engine
- 5.2. Introduction on OpenSSL provider
- 5.3. PKCS#11 Plugin

**Note:**

*If several Linux processes want to access EdgeLock A30 at the same time, it is necessary to use the Access Manager. The Access Manager manages the simultaneous access of several Linux processes to EdgeLock A30. Linux client processes are connected to the Access Manager via the JRCPv1 protocol.*

[Figure 12](#) shows the principal hardware setup. Please refer to the MW documentation chapter 2.4.2. Connecting NX Secure Authenticator with RaspberryPi for more details



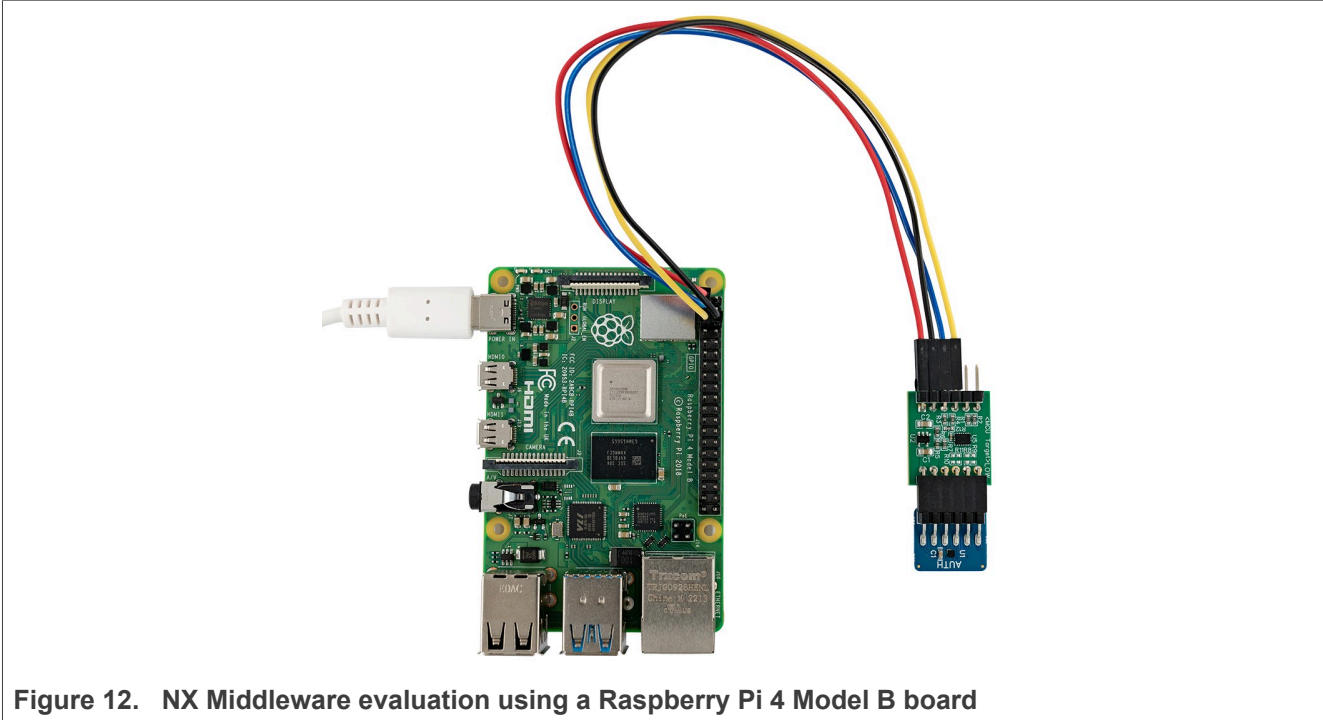


Figure 12. NX Middleware evaluation using a Raspberry Pi 4 Model B board

Figure 13 and Table 4 are showing the detailed connection of the EdgeLock A30 to the Raspberry Pi:

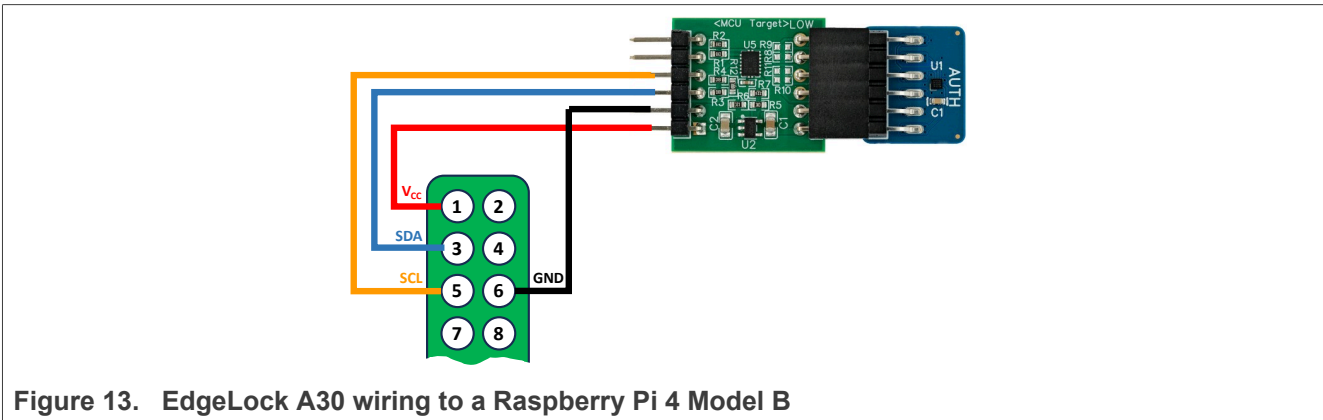


Figure 13. EdgeLock A30 wiring to a Raspberry Pi 4 Model B

Table 4. EdgeLock A30 wiring to a Raspberry Pi 4 Model B board

Raspberry Pi 4 Model B (# jumper - # pin)	Level Shifter Board (# jumper - # pin)
J8-P5 (SCL)	SCL (HIGH<MCU)
J8-P3 (SDA)	SDA (HIGH<MCU)
J8-P6 (GND)	GND (HIGH<MCU)
J8-P1 (3V3)	VCC (HIGH<MCU)

## 5 EdgeLock 2 Go service for EdgeLock A30

### 5.1 Overview

EdgeLock A30 products are delivered with an NXP trust-provisioned device unique application private EC key and application X.509 certificate containing the corresponding public EC key. The EdgeLock A30 application credentials can be used for Sigma-I Authentication.

To simplify the OEMs products process and reduce the production cost the EdgeLock A30 device UID and the application X.509 certificate can be downloaded via the EdgeLock 2 Go service. This eliminates the need for OEMs to read the credential from each individual EdgeLock A30 device.

EdgeLock A30 reels are shipped with a label containing an access code (reference code and authorization key).



Figure 14. EdgeLock A30 reel

To download the EdgeLock A30 UIDs and application certificates can be simple done by the following steps:

- Go to <https://www.edgelo2go.com/downloads> and enter the reference code and authorization key.
- After successful registration, the Wafer Map, Device UIDs and the application X.509 certificates can be downloaded.

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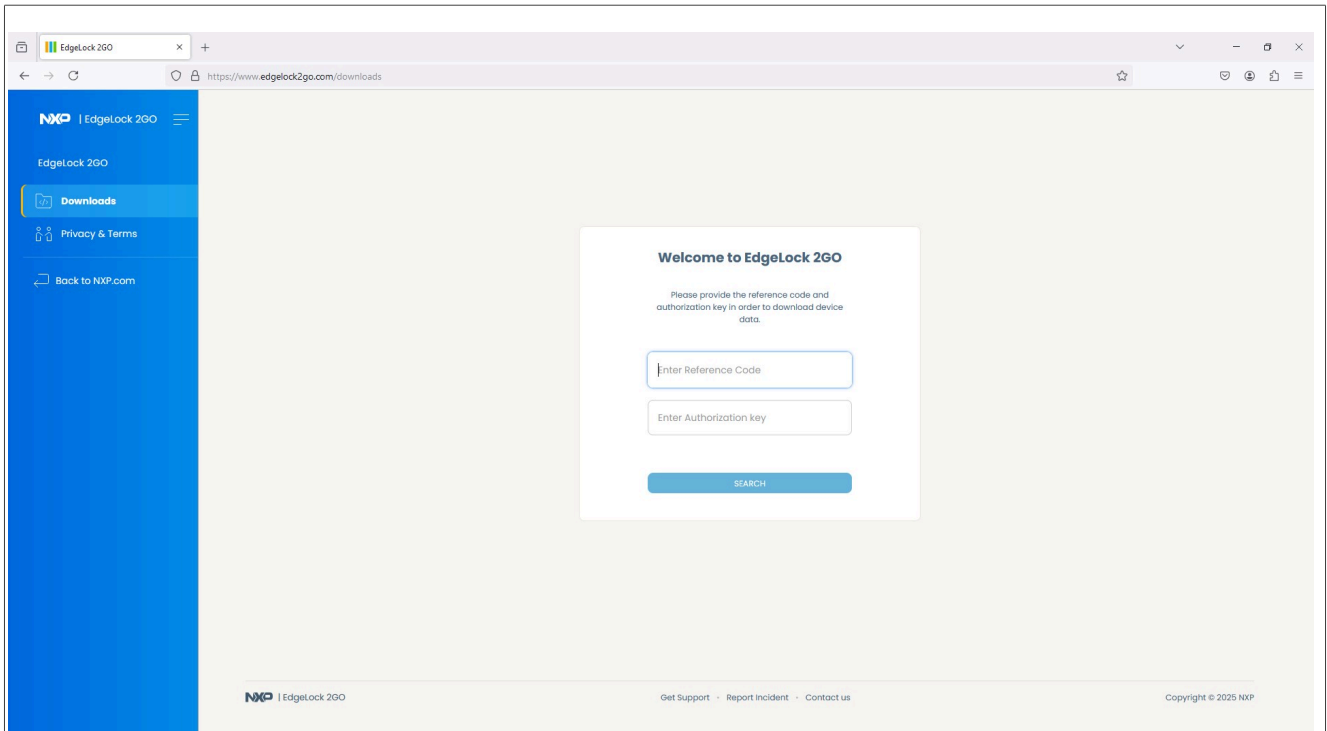
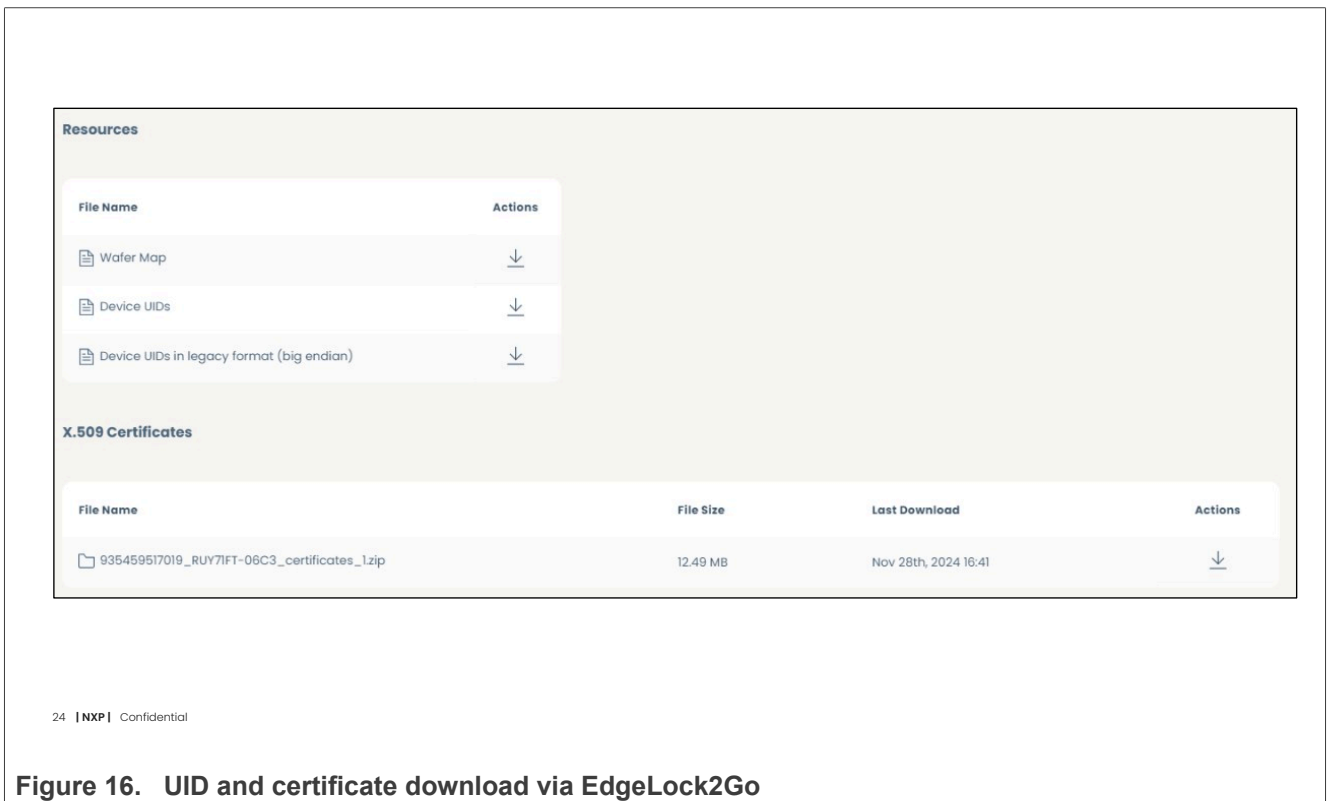


Figure 15. EdgeLock2Go web portal



24 | NXP | Confidential

Figure 16. UID and certificate download via EdgeLock2Go



## 6 Supported EdgeLock A30 documentation

[Table 5](#) summarizes the EdgeLock A30 dedicated documents.

**Note:** Click on the hyperlink in the app note numbers to download the document, or click on the hyperlink in the app note title to navigate through the specific app note section

Table 5. Dedicated EdgeLock A30 documentation

Documentation number	Title
DS9767xx	Edgelock A30 Secure Authenticator data sheet
AD9772xx	Edgelock A30 Delivery specification
AN14559	Migration Guide from EdgeLock A5000 to EdgeLock A30
<a href="#">Global Platform</a>	GlobalPlatform Technology- APDU Transport over SPI / I <sup>2</sup> C Version 1.0, January 2020
<a href="#">UM10204</a>	I <sup>2</sup> C-bus specification and user manual

## 7 Appendix

### 7.1 EdgeLock A30 application circuit diagram

Figure 17 shows an application circuit diagram with the following design considerations:

- Power-On-Reset
  - It is recommended that the hostcontroller can perform a Power-On-Reset by controlling  $V_{CC}$ .
  - It is possible to supply A30 via the MCU/MPU GPIO. The GPIO shall be able to deliver current up to 15 mA.
- A30 triggers a Reset via  $T=1'$  over I<sup>2</sup>C protocol
  - Using a proprietary NXP S-Blocks chip reset request/response.
- A30 enables Deep Power Down via  $T=1'$  over I<sup>2</sup>C protocol
  - Using a proprietary NXP S-Block Deep Power Down request/response.

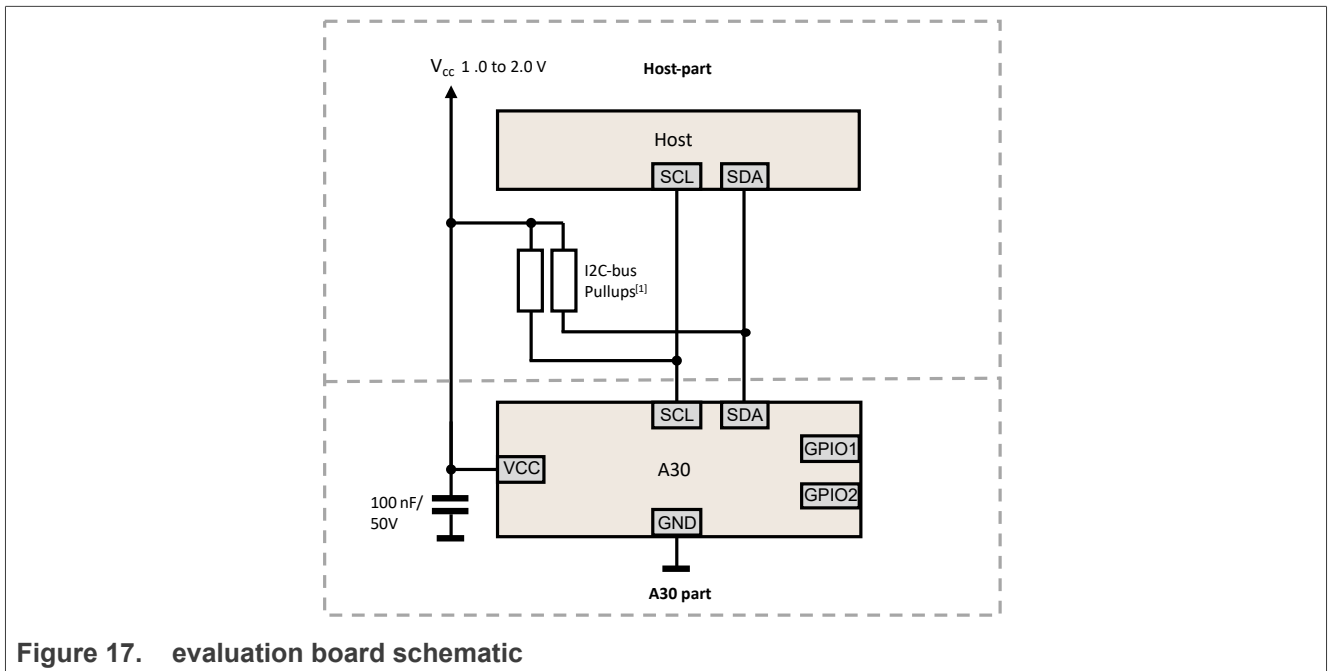


Figure 17. evaluation board schematic

**Note:** [1] .. According [UM10204](#) I<sup>2</sup>C-bus specification and user manual Rev 7, chapter 7.1 Pull-up resistor sizing

7.2 EdgeLock A30 evaluation board schematic

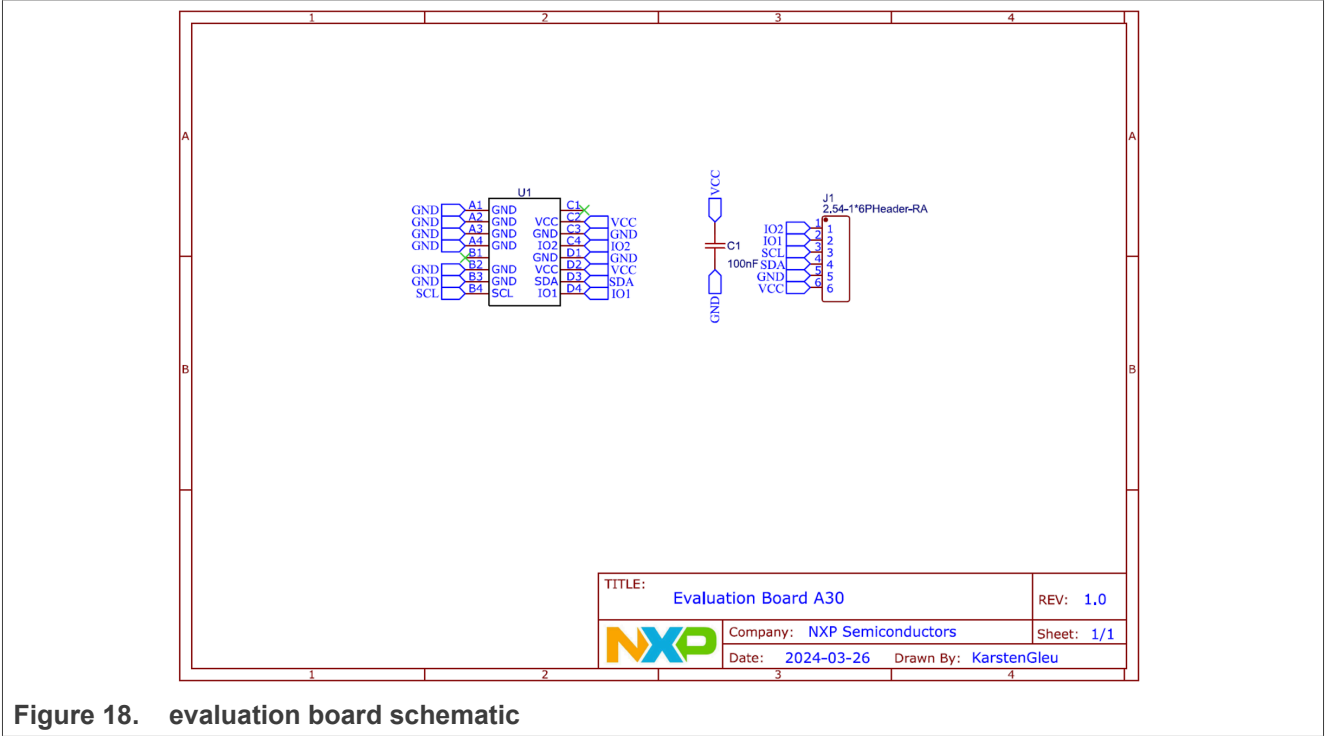


Figure 18. evaluation board schematic

7.3 Level shifter board schematic

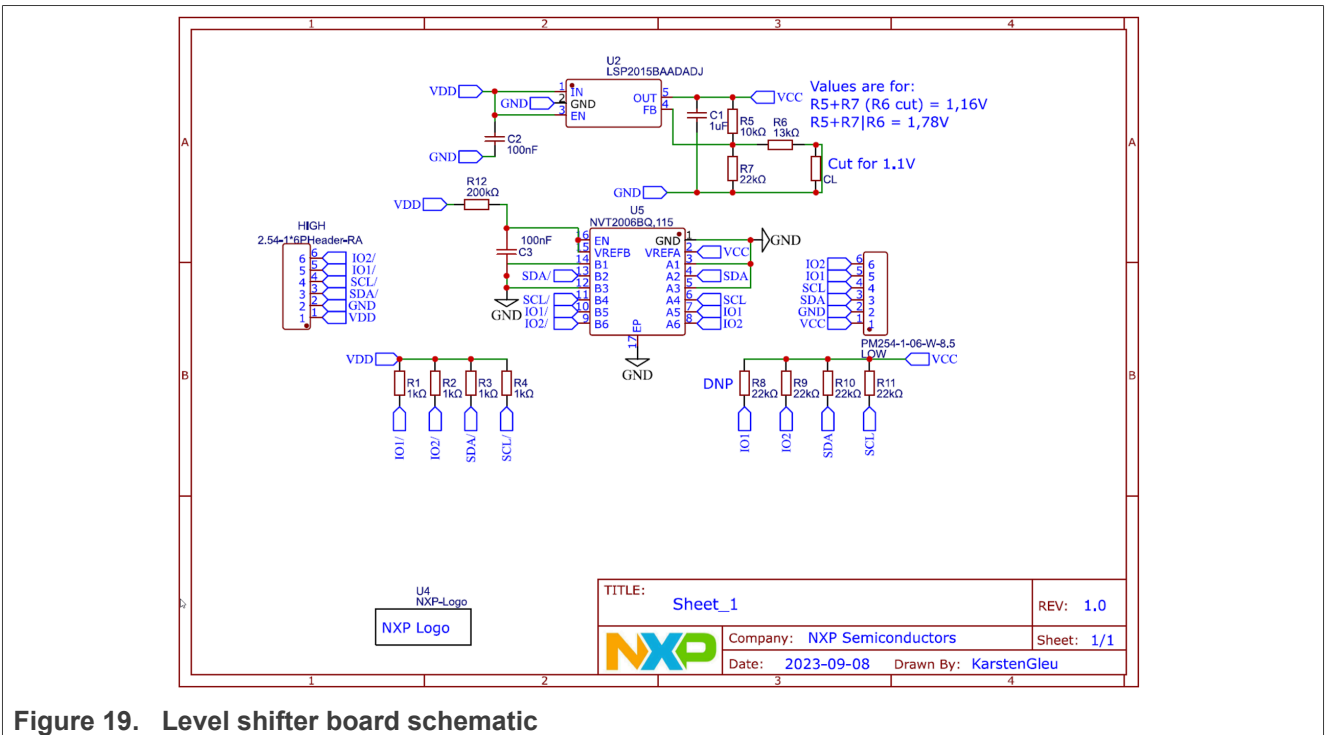


Figure 19. Level shifter board schematic

## 8 Revision history

Table 6. Revision history

Revision number	Date	Description
AN14238 v.1.0	15 January 2025	Initial version

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